



DOCUMENT CHANGE REQUEST

DCR number 1614 Changes required for: General

Date: 2023/11/30

Date sent: 2023/11/29

Status: IMPLEMENTED

Originator: Steve Thacker

Organisation: ESCC Executive Secretariat

Title: Resistor Fixed Chip Metal Foil based on Type SMR-PW, SMV-PW

Number: 4001/028

Issue: 5

Other documents affected:

Page:

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Paragraph:

1.9.1

Original wording:

The terminal finish shall be electroplated tin-lead (with 30% to 80% tin; remainder lead) to a maximum thickness of 20m.

Proposed wording:

Correct Para. 1.9.1 maximum finish thickness to be 70m (was 20m).

i.e. to read:

The terminal finish shall be electroplated tin-lead (with 30% to 80% tin; remainder lead) to a maximum thickness of 70m

Justification:

This is simply a typographic error introduced in the current issue by DCR1585

Attachments:

N/A

Modifications:

N/A

Approval signature:

Date signed:

2023-11-30